

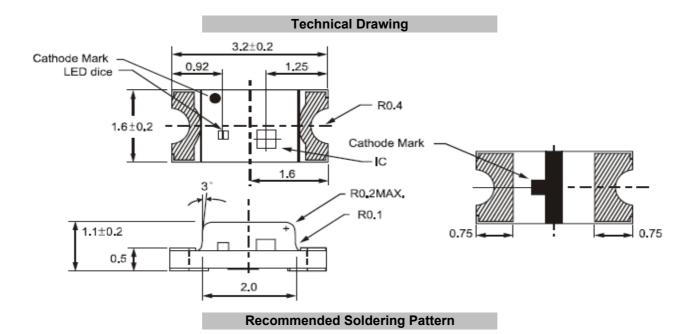


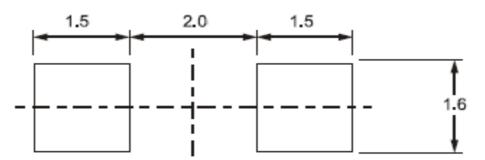
Applications

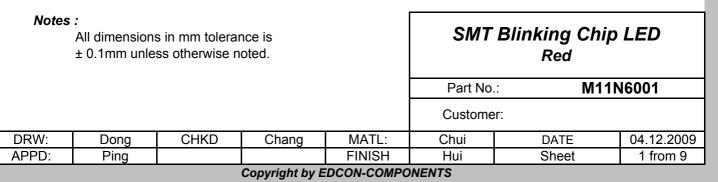
Interior automotive lighting

 Optical indicators
 Communication Products
 Backlighting

 Toys







email: info@edcon-components.com





Absolute Maximum Ratings

Ta=25°C

Item	Symbol	GaP	Unit
Power Dissipation	PD		mW
DC Forward Current	I _F	12	mA
Plused Forward Current	I _{FP} *	100	mA
Reverse Voltage	V _R	5	V
Operating Temperature	T _{OP}	-25 to 80	°C
Storage Temperature	T _{ST}	-20 to 85	°C

* 0.1 msec pulse, 10% duty cycle

Electrcal / Optical Characteristics

Ta=25°C

Ermitting Color		Red						
Material		GaP						
Forward Current	typ.	20	A					
Forward Current	max.		A					
Wavelength	λP	700	nm					
typ.	Δλ		nm					
Color Temperature	min.		K					
color remperature	max.		K					
Luminous Intensity *	min.	2.4	mcd					
Lumnous intensity	typ.	6.0	mcd					
Bulas Data	min.	2.0	Hz					
Pulse Rate VDD = 5V	typ.	2.4	Hz					
VDD - 5V	max.	3.0	Hz					
Reverse Current	max.		μA					
Viewing Angle	2Θ1/2	120						

* Per NIST standards

					SMT Blinking Chip LED Red			
					Part No.: M11N6001			
					Custome	er:		
DRW:	Dong	CHKD	Chang	MATL:	Chui	DATE	04.12.2009	
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Directive Characteristics

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				-	Part No.:	M1	1N6001
					Customer:		
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Curvs

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					Part No	.: M1 1	N6001				
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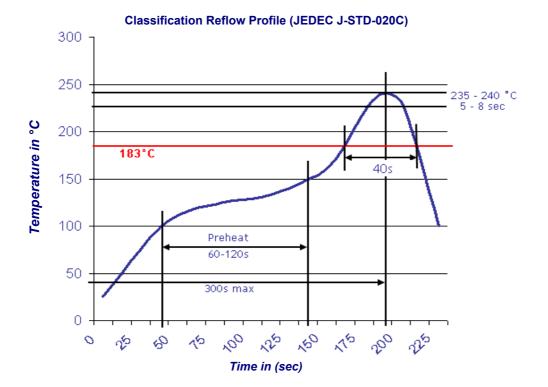
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Solder Condition

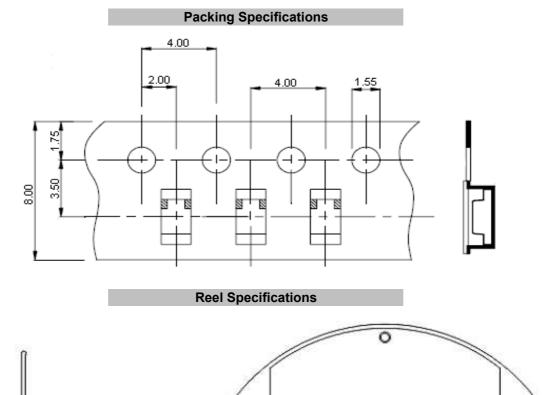
Lead Free Solder

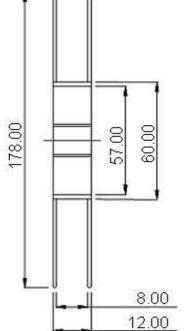


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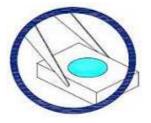




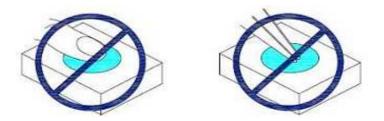
Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although ist characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of th LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools



2. Do not directly touch or handle the silicone lens surfance. It may damage the internal circuitry.



3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratch the silicone lens or damage the internal circuitry.



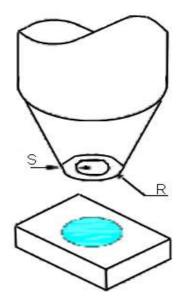
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					Part No.: M11N6001		
					Custome	er:	
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- 4. The outer diameter of the TOP LED pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
- 5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



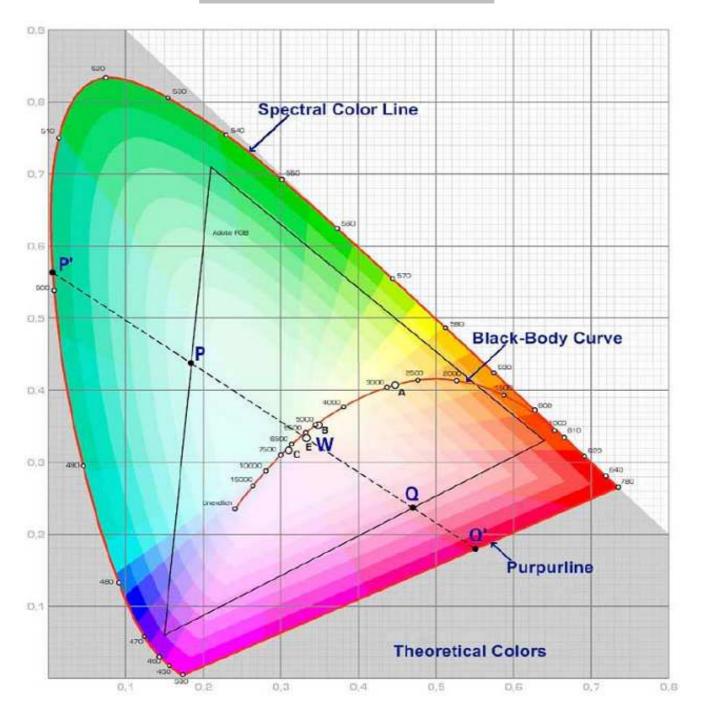
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					Part No.: M11N6001		
					Custome	er:	
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Color table curve



				SMT	Blinking Chip Red	LED	
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					Custome	er:	
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